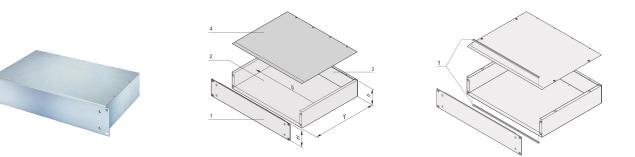


20860-122 MULTIPACPRO 19" CHASSIS, STEEL, ALZN, PLAIN TOP AND BASE, 1 U, 340 MM



KEY FEATURES

Steel (AIZn coated) with AI extrusion front panel

Detachable front and rear panel for easy machining

IP 20, in accordance with IEC 60529

Supplied as space-saving flat-pack

EMC shielding: Approx. 20dB(A) at 2GHz without shielding material. >40dB(A) at 1Ghz with addition of stainless steel gasket between front panel and case body

Internal and external dimensions in accordance with: IEC 60297-3-101

EMC shielding: Approx. 20dB(A) at 2 GHz without shielding material. >40dB(A) at 1 GHz with addition of stainless steel gasket between front panel and case body

PRODUCT ATTRIBUTES

Product Type: Subrack/Chassis
Product Family: MultipacPRO
Type: Solid
Rack Height: 1 U
Depth: 340 mm
Usable Width: 447 mm
EMC Shielding: No (Retrofittable)
Mounting: Rack

ADDITIONAL PRODUCT DETAILS

This 19" chassis is a form of subrack which accepts horizontal board mounting or the mounting of non-standard components like transformers or other heavy load accessories typically mounted on a chassis plate. This version is producted from sheet metal, Al-Zn coated and have plain top and bottom covers.

Please order front handles separately.

Telescopic slides cannot be used.

Further versions with steel front panel (pizza box) available on request.

Standardised internal mounting kits cannot be used.

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